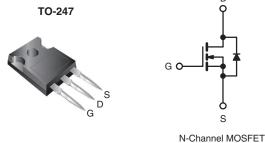
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.018			
Q _g (Max.) (nC)	110				
Q _{gs} (nC)	29				
Q _{gd} (nC)	38				
Configuration	Single				



FEATURES

- · Dynamic dV/dt Rating
- · Isolated Central Mounting Hole
- 175 °C Operating Temperature
- Ease of Paralleling
- · Simple Drive Requirements
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247
Lead (Pb)-free	IRFP048PbF
	SiHFP048-E3
SnPb	IRFP048
	SiHFP048

S

ABSOLUTE MAXIMUM RATINGS $T_C = 25 ^{\circ}C$, unless otherwise noted							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	60	V		
Gate-Source Voltage			V _{GS}	± 20	v		
Continuous Drain Current ^e	V _{GS} at 10 V	T _C = 25 °C	- I _D	70			
Continuous Drain Current	VGS at TO V	T _C = 100 °C		52	А		
Pulsed Drain Current ^a			I _{DM}	290			
Linear Derating Factor				1.3	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	200	mJ		
Maximum Power Dissipation	T _C =	25 °C	PD	P _D 190			
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature) ^d	for 10 s			300			
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in		
				1.1	N · m		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, $L = 43 \mu\text{H}$, $R_G = 25 \Omega$, $I_{AS} = 73 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq 72$ A, $dI/dt \leq 200$ A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^{\circ}C.$

d. 1.6 mm from case.

e. Current limited by the package (die current = 73 A).

* Pb containing terminations are not RoHS compliant, exemptions may apply



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THERMAL RESISTANCE RA	TINGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		40				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24 -			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.80					
SPECIFICATIONS $T_J = 25 \degree C$,	unless otherv	vise noted						
PARAMETER	SYMBOL		CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT
Static					1		1	1
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 25	ο μΑ	60	-	-	v
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	Reference		-	-	0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		' _{GS} , I _D = 25		2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$			-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		= 44 A ^b	-	-	0.018	Ω
Forward Transconductance	g _{fs}	$V_{DS} = 2$	25 V, I _D = 4	4 A ^b	20	-	-	S
Dynamic					L		L	
Input Capacitance	C _{iss}		0.14		-	2400	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	1300	-	pF	
Reverse Transfer Capacitance	C _{rss}	f = 1.0	f = 1.0 MHz, see fig. 5		-	190	-	
Total Gate Charge	Qg			= 72 A, V _{DS} = 48 V ee fig. 6 and 13 ^b	-	-	110	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			-	-	29	
Gate-Drain Charge	Q _{gd}	1	566 H		-	-	38	
Turn-On Delay Time	t _{d(on)}				-	8.1	-	
Rise Time	tr	- 		7Ο Λ	-	250	-	1
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 30 \text{ V}, \text{ I}_D = 72 \text{ A},$ $R_G = 9.1 \Omega, R_D = 0.34 \Omega, \text{ see fig. } 10^{\text{b}}$		-	210	-	ns	
Fall Time	t _f	1			-	250	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	nH	
Internal Source Inductance	L _S			-	13	-		
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	70 ^c	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	290		
Body Diode Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 73 \text{ A}, V_{GS} = 0 \text{ V}^{b}$			-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 72 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	120	180	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.50	0.80	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn	-on time is	negligible (turr	on is dor	ninated b	y L _S and I	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %. c. Current limited by the package (die current = 73 A).



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

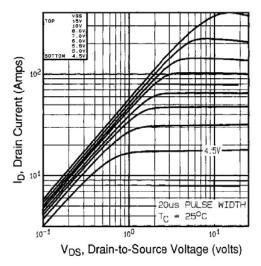


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^\circ C$

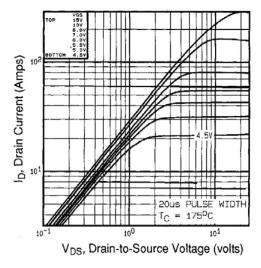


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$

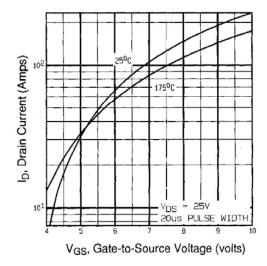


Fig. 3 - Typical Transfer Characteristics

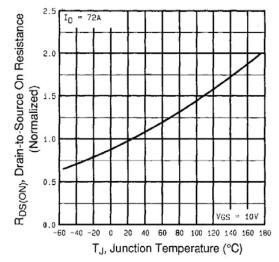


Fig. 4 - Normalized On-Resistance vs. Temperature

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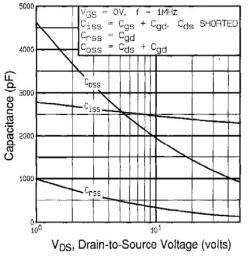


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

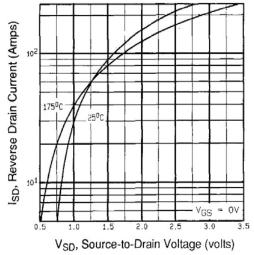


Fig. 7 - Typical Source-Drain Diode Forward Voltage

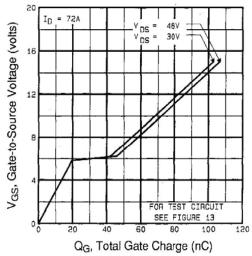
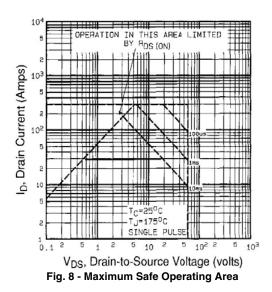


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



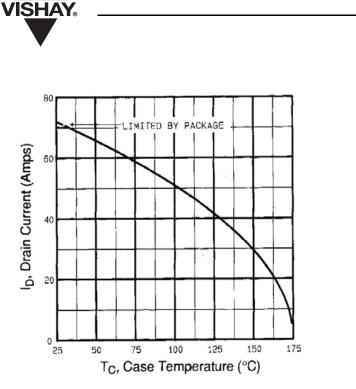


Fig. 9 - Maximum Drain Current vs. Case Temperature



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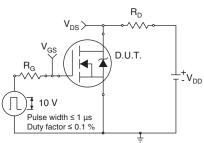


Fig. 10a - Switching Time Test Circuit

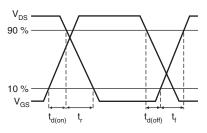


Fig. 10b - Switching Time Waveforms

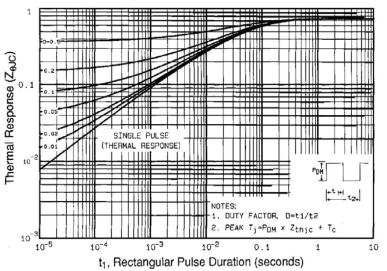


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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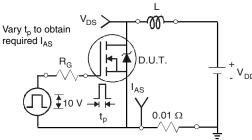


Fig. 12a - Unclamped Inductive Test Circuit

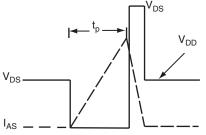
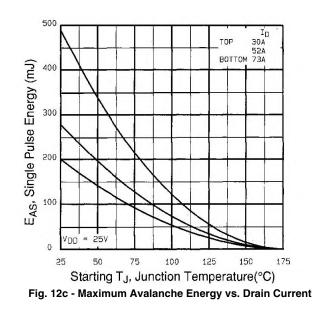


Fig. 12b - Unclamped Inductive Waveforms



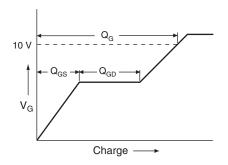
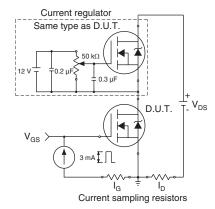


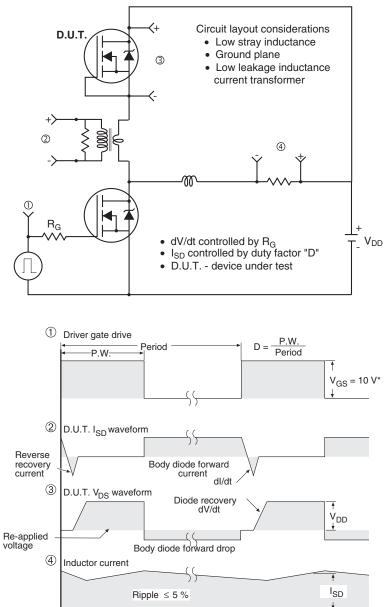
Fig. 13a - Basic Gate Charge Waveform





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* V_{GS} = 5 V for logic level and 3 V drive devices

Fig. 14 - For N-Channel

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